



PRODUCT DATASHEET



- SMD Display
- ▶ 0.28'' (7mm) [•]8.[•]8.[•]8.
- Red (625nm)

NOR42D91GS NOR42D92GS



SMD Display Series Compliant

FEATURES:

- Package: SMD Numeral Triple Digits Display
- Forward Current: 20mA per diode
- Pulse Current: 90mA per diode
- Forward Voltage (typ.): 2.0V per diode
- Luminous Intensity (typ.): 10mcd@20mA per diode
- Colour: Red
- Wavelength: 625nm
- Materials:
 - Die: GaAlAs
 - Resin: Epoxy (White Diffused)
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+105°C
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 200pcs/reel

SMD Display Series

APPLICATIONS:

- 7-Segment Display
- Signal Display
- Information Board
- Counter

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CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|--|------------------|-----------|-------|
| Forward Current * | I _F | 25 | mA |
| Peak Forward Current Duty 1/10 @10KHz | I _{FP} | 90 | mA |
| Reverse Current @5V | I _R | 10 | μΑ |
| Power Dissipation | P _D | 70 | mW |
| Debating Liner per Segment (from 25°C) | | 0.28 | mA/°C |
| Operating Temperature | T _{OPR} | -40~+105 | °C |
| Storage Temperature | T _{STG} | -40~+1005 | °C |

1. All parameters are per diode.

Electrical & Optical Characteristics (Ta=25°C)

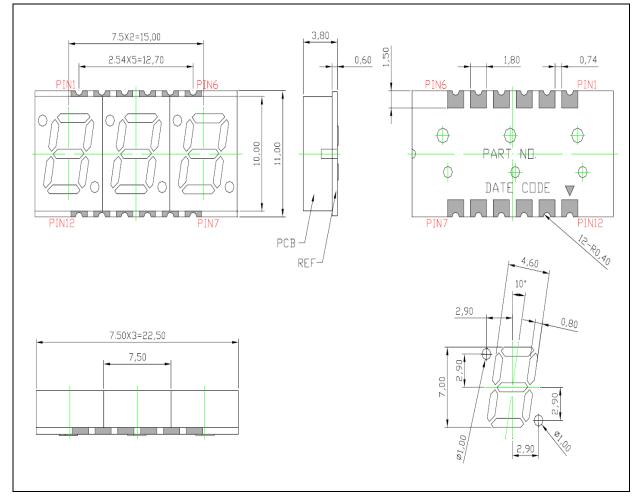
| Darameter | Symbol | Values | | | Unit | Test |
|---------------------------------|----------------------|--------|------|------|------|----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Onit | Condition |
| Forward Voltage | $V_{\rm F}$ | | 2.0 | 2.6 | V | I _F =20mA |
| Luminous Intensity | Ι _ν | | 10 | | mcd | I _F =20mA |
| Dominant Wavelength | λ_{D} | | 625 | | nm | I _F =20mA |
| Spectral Line Half Bandwidth | Δλ | | 20 | | nm | I _F =20mA |

1. Luminous intensity (I_v) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle($2\theta_{1/2}$) ±5%



OUTLINE DIMENSION:

Package Dimension:



1. All dimensions are in millimetre (mm).

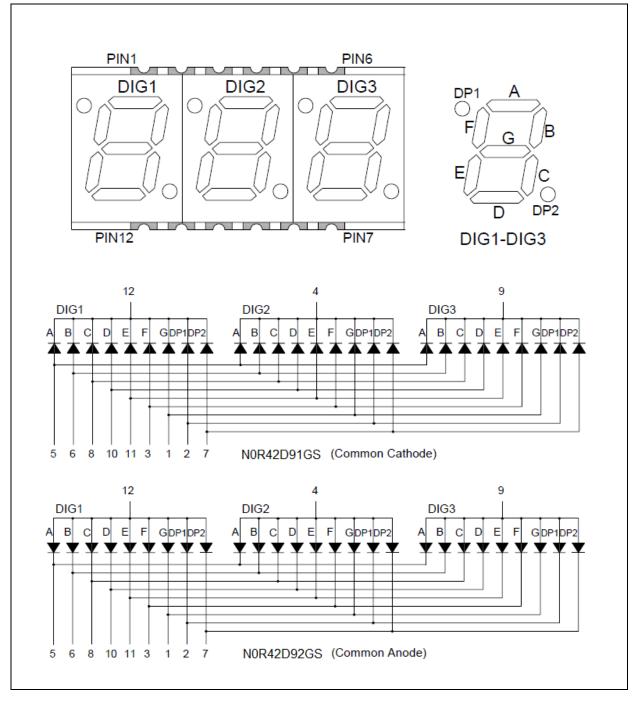
3

2. Tolerance ±0.2mm, unless otherwise noted.



Circuit Diagram:

Internal Circuit:



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Electrical Connection:

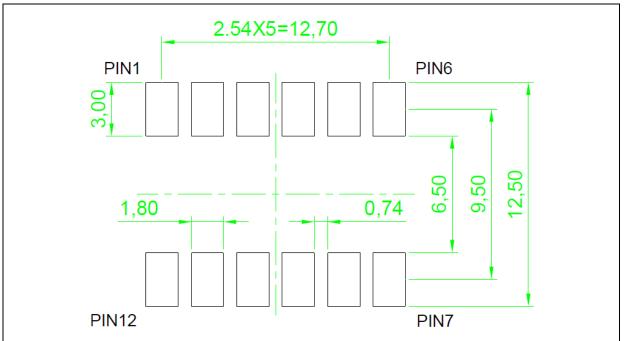
NOR42D91GS:

| Pin no. | Function | Pin no. | Function |
|---------|---------------------|---------|---------------------|
| 1 | Anode G | 7 | Anode DP2 |
| 2 | Anode DP1 | 8 | Anode C |
| 3 | Anode F | 9 | Common Cathode DIG3 |
| 4 | Common Cathode DIG2 | 10 | Anode D |
| 5 | Anode A | 11 | Anode E |
| 6 | Anode B | 12 | Common Cathode DIG1 |

NOR42D92GS:

| Pin no. | Function | Pin no. | Function |
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Recommended Soldering Pad:





BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

| Code | Min. | Max. | Unit |
|------|------|------|------|
| D | 1.6 | 2.6 | V |

Luminous Intensity Classifications (I_F = 20mA):

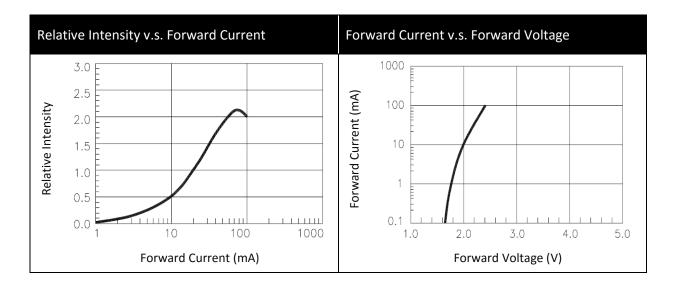
| Code | Min. | Max. | Unit |
|------|------|------|------|
| К | 3 | 20 | mcd |

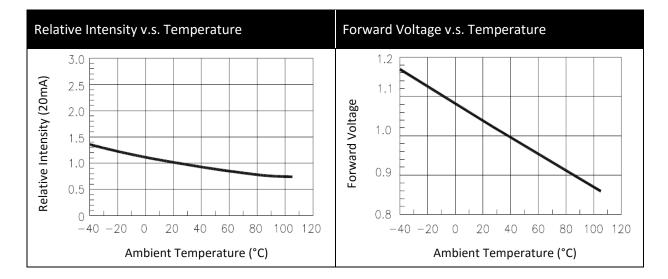
Dominant Wavelength Classifications ($I_F = 20mA$):

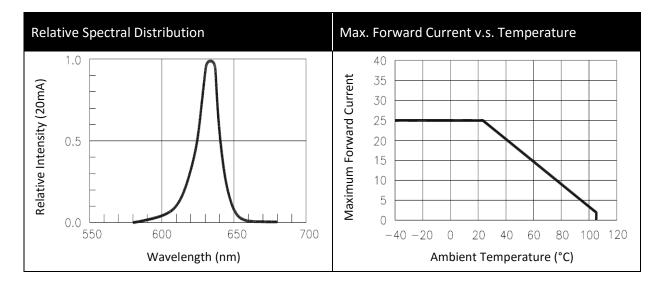
| Code | Min. | Max. | Unit |
|------|------|------|------|
| 1 | 619 | 622 | |
| 2 | 622 | 626 | nm |
| 3 | 626 | 629 | |



ELECTRO-OPTICAL CHARACTERISTICS:





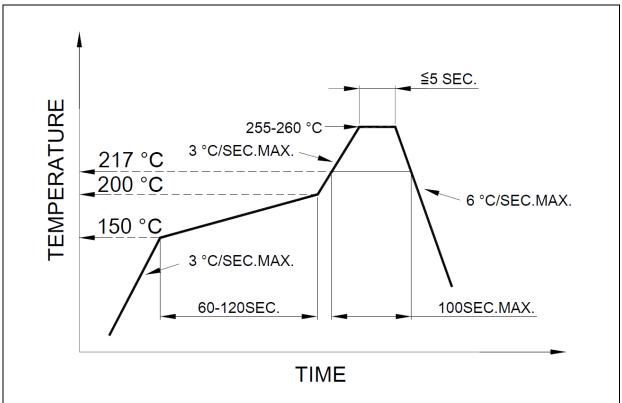


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RECOMMENDED SOLDERING PROFILE:





Note:

- 1. Recommend reflow temperature 245°C. Maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 1 time.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.

PACKING SPECIFICATION:



200pcs/reel

PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

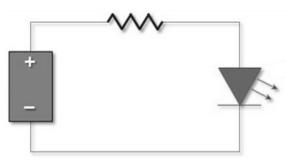
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 12hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

| Version | Date | Summary of Revision |
|---------|------------|---------------------|
| A1.0 | 02/11/2017 | Datasheet set-up. |

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